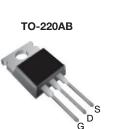
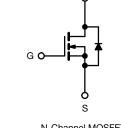
**Vishay Siliconix** 



Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	600				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 1.2				
Q <sub>g</sub> max. (nC)	39				
Q <sub>gs</sub> (nC)	10				
Q <sub>gd</sub> (nC)	19				
Configuration	Single				





N-Channel MOSFET

#### **FEATURES**

- Ultra low gate charge
- Reduced gate drive requirement
- Enhanced 30 V, V<sub>GS</sub> rating
- Reduced C<sub>iss</sub>, C<sub>oss</sub>, C<sub>rss</sub>
- Extremely high frequency operation
- Repetitive avalanche rated
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

#### DESCRIPTION

This new series of low charge power MOSFETs achieve significantly lower gate charge over conventional Power MOSFETs. Utilizing the new LCDMOS technology, the device improvements are achieved without added product cost, allowing for reduced gate drive requirements and total system savings. In addition reduced switching losses and improved efficiency are achievable in a variety of high frequency applications. Frequencies of a few MHz at high current are possible using the new low charge power MOSFETs.

These device improvements combined with the proven ruggedness and reliability that are characteristic of power MOSFETs offer the designer a new standard in power transistors for switching applications.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFBC40LCPbF			
Lead (FD)-free	SiHFBC40LC-E3			
SnPb	IRFBC40LC			
	SiHFBC40LC			

<b>ABSOLUTE MAXIMUM RATINGS (T</b> C	= 25 °C, unl	ess otherwis	e noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	600	- V
Gate-Source Voltage			V <sub>GS</sub>	± 30	v
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	I <sub>D</sub>	6.2	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		3.9	А
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	25	
Linear Derating Factor				1.0	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	530	mJ
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	6.2	А
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	13	mJ
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	125	W
Peak Diode Recovery dV/dt °			dV/dt	3.0	V/ns
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	- °C
Soldering Recommendations (Peak temperature) <sup>d</sup> for 10 s				300	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in
Mounting Torque				1.1	N · m

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 25 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 6.2$  A (see fig. 12). c.  $I_{SD} \le 6.2$  A, dl/dt  $\le 80$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.

c. 
$$I_{SD} \le 6.2$$
 A, dI/dt  $\le 80$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface R <sub>thCS</sub> 0.50		0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		*			•		•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 1 mA	-	0.70	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V	<sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	_	4.0	v
Gate-Source Leakage	I <sub>GSS</sub>		$G_{GS} = \pm 20$	-	_	± 100	nA
	'GSS		$V_{\rm DS} = 600 \text{ V}, \text{ V}_{\rm DS} = 0 \text{ V}$		_	100	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		/ <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 3.7 A <sup>b</sup>	-	-	1.2	Ω
Forward Transconductance	<b>g</b> <sub>fs</sub>	V <sub>DS</sub> = 10	00 V, I <sub>D</sub> = 3.7 A <sup>b</sup>	3.7	-	-	S
Dynamic						1	
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$	-	1100	-	[
Output Capacitance	C <sub>oss</sub>		$_{\text{GS}} = 0.7$ $_{\text{DS}} = 25$ V	-	140	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		MHz, see fig. 5	-	15	-	1
Total Gate Charge	Qq			-	-	39	nC
Gate-Source Charge	Q <sub>qs</sub>	V <sub>GS</sub> = 10 V	$I_D = 6.2 \text{ A}, V_{DS} = 360 \text{ V},$	-	-	10	
Gate-Drain Charge	Q <sub>gd</sub>	-	see fig. 6 and 13 <sup>b</sup>	-	-	19	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 300 V, $I_D$ = 6.2 A $R_g$ = 9.1 $\Omega,~R_D$ = 47 $\Omega,~see$ fig. 10 $^{\rm b}$		-	12	-	- ns
Rise Time	t <sub>r</sub>			-	20	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	27	-	
Fall Time	t <sub>f</sub>			-	17	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	- nH
Internal Source Inductance	L <sub>S</sub>	<ul> <li>package and ce die contact</li> </ul>	die contact		7.5	-	
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.6	-	3.9	Ω
Drain-Source Body Diode Characteristic					•	•	•
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6.2	_
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	25	A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>5</sub>	$_{\rm S}$ = 6.2 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 6.2 A, dl/dt = 100 A/µs <sup>b</sup>		-	440	680	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	2.1	3.2	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )					

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

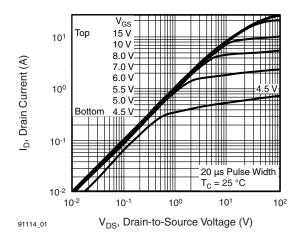


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

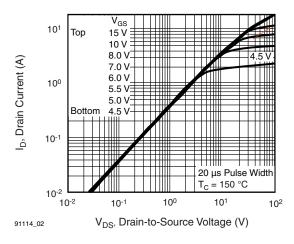


Fig. 2 - Typical Output Characteristics,  $T_C = 150 \ ^\circ C$ 

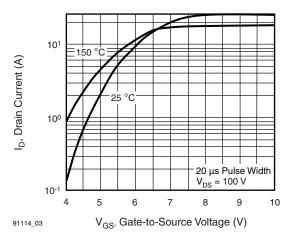


Fig. 3 - Typical Transfer Characteristics

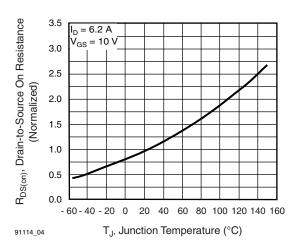


Fig. 4 - Normalized On-Resistance vs. Temperature

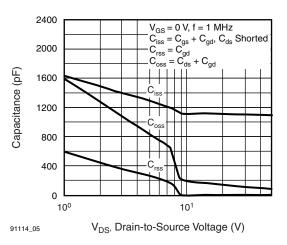


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

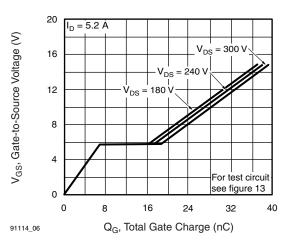


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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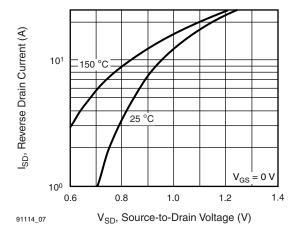


Fig. 7 - Typical Source-Drain Diode Forward Voltage

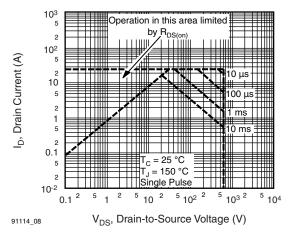


Fig. 8 - Maximum Safe Operating Area

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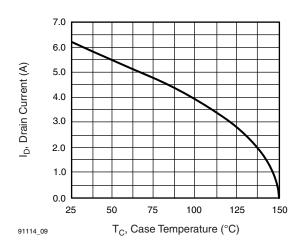


Fig. 9 - Maximum Drain Current vs. Case Temperature

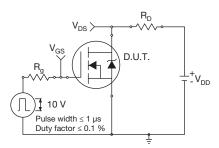


Fig. 10a - Switching Time Test Circuit

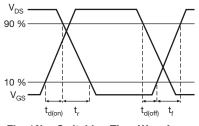


Fig. 10b - Switching Time Waveforms

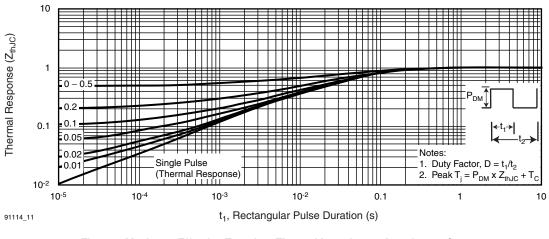


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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### IRFBC40LC, SiHFBC40LC Vishay Siliconix

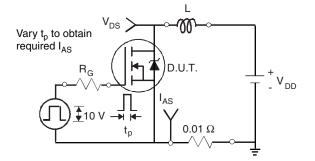


Fig. 12a - Unclamped Inductive Test Circuit

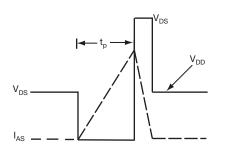


Fig. 12b - Unclamped Inductive Waveforms

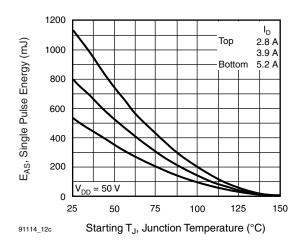


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

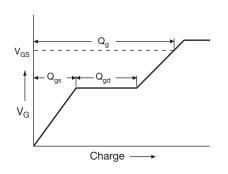


Fig. 13a - Basic Gate Charge Waveform

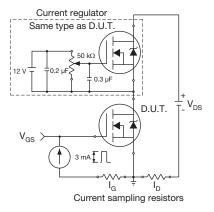
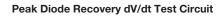
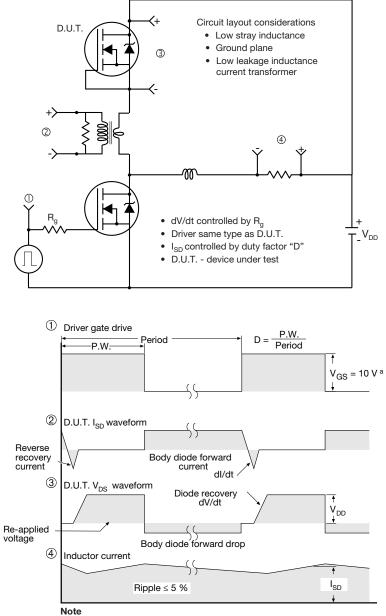


Fig. 13b - Gate Charge Test Circuit



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a.  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

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